

RELIABILITY REPORT FOR

DS1321, Rev A3

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport/dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts

AfT = Acceleration factor due to Temperature

tu = Time at use temperature (e.g. 55°C)

ts = Time at stress temperature (e.g. 125°C)

k = Boltzmann's Constant (8.617 x 10-5 eV/°K)

Tu = Temperature at Use (°K)
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Ts = Temperature at Stress (°K) Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
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The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 30814 FITS: 3.7

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volts

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data.

Device Information:

Process: 1P, 1M, 0.8um, Neg ZTC P1R, PdplDiode , N+ESD II, WJ B

Passivation: Passivation w/Nov TEOS Oxide-Nitride

Die Size: 108 x 78 Number of Transistors: 3000

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 175 Å

OPERATING LIFE						
DESCRIPTION	DATE CODE CONDITION		READPOINT	QTY	FAILS	FA#
INFANT LIFE	9702	125C, 7.0 VOLTS	48 HRS	315	0	
HIGH VOLTAGE LIFE	9702	125C, 7.0 VOLTS	1000 HRS	116	0	
INFANT LIFE	9724	125C, 7.0 VOLTS	48 HRS	315	0	
HIGH VOLTAGE LIFE	9724	125C, 7.0 VOLTS	1000 HRS	116	0	
			Total:		0	
TEMPERATURE CY	CLE					
DESCRIPTION	DATE CODE CONDITION		READPOINT	QTY	FAILS	FA#
TEMP CYCLE	9702	-55C TO 125C	1000 CYS	77	0	
TEMP CYCLE	9724	-55C TO 125C	1000 CYS	77	0	
			Total:		0	
TEMPERATURE HU	MIDITY BI	AS				
DESCRIPTION	DATE CODE CONDITION		READPOINT	QTY	FAILS	FA#
HAST	9702	120C, 85%R.H.,5.5V	100 HRS	77	1	970058
HAST	9724	120C, 85%R.H.,5.5V	100 HRS	77	0	
			Total:		1	
UNBIASED MOISTU	IRE RESIS	TANCE				
DESCRIPTION	DATE CODE CONDITION		READPOINT	QTY	FAILS	FA#
HAST, NO BIAS	9702	120C, 85% R.H.	200 HRS	44	0	
HAST, NO BIAS	9724	120C, 85% R.H.	200 HRS	44	0	

Total: 0

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